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Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	42
Number of Logic Elements/Cells	336
Total RAM Bits	-
Number of I/O	120
Number of Gates	4000
Voltage - Supply	4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	160-BQFP
Supplier Device Package	160-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/intel/epf8452aqc160-3ac

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

...and More Features

- Peripheral register for fast setup and clock-to-output delay
- Fabricated on an advanced SRAM process
- Available in a variety of packages with 84 to 304 pins (see Table 2)
- Software design support and automatic place-and-route provided by the Altera® MAX+PLUS® II development system for Windows-based PCs, as well as Sun SPARCstation, HP 9000 Series 700/800, and IBM RISC System/6000 workstations
- Additional design entry and simulation support provided by EDIF 2 0 0 and 3 0 0 netlist files, library of parameterized modules (LPM), Verilog HDL, VHDL, and other interfaces to popular EDA tools from manufacturers such as Cadence, Exemplar Logic, Mentor Graphics, OrCAD, Synopsys, Synplicity, and Veribest

Table 2. FLE.	Table 2. FLEX 8000 Package Options & I/O Pin Count Note (1)													
Device	84- Pin PLCC	100- Pin TQFP	144- Pin TQFP	160- Pin PQFP	160- Pin PGA	192- Pin PGA	208- Pin PQFP	225- Pin BGA	232- Pin PGA	240- Pin PQFP	280- Pin PGA	304- Pin RQFP		
EPF8282A	68	78												
EPF8282AV		78												
EPF8452A	68	68		120	120									
EPF8636A	68			118		136	136							
EPF8820A			112	120		152	152	152						
EPF81188A							148		184	184				
EPF81500A										181	208	208		

Note:

General Description

Altera's Flexible Logic Element MatriX (FLEX®) family combines the benefits of both erasable programmable logic devices (EPLDs) and field-programmable gate arrays (FPGAs). The FLEX 8000 device family is ideal for a variety of applications because it combines the fine-grained architecture and high register count characteristics of FPGAs with the high speed and predictable interconnect delays of EPLDs. Logic is implemented in LEs that include compact 4-input look-up tables (LUTs) and programmable registers. High performance is provided by a fast, continuous network of routing resources.

⁽¹⁾ FLEX 8000 device package types include plastic J-lead chip carrier (PLCC), thin quad flat pack (TQFP), plastic quad flat pack (PQFP), power quad flat pack (RQFP), ball-grid array (BGA), and pin-grid array (PGA) packages.

FLEX 8000 devices contain an optimized microprocessor interface that permits the microprocessor to configure FLEX 8000 devices serially, in parallel, synchronously, or asynchronously. The interface also enables the microprocessor to treat a FLEX 8000 device as memory and configure the device by writing to a virtual memory location, making it very easy for the designer to create configuration software.

The FLEX 8000 family is supported by Altera's MAX+PLUS II development system, a single, integrated package that offers schematic, text—including the Altera Hardware Description Language (AHDL), VHDL, and Verilog HDL—and waveform design entry, compilation and logic synthesis, simulation and timing analysis, and device programming. The MAX+PLUS II software provides EDIF 2 0 0 and 3 0 0, library of parameterized modules (LPM), VHDL, Verilog HDL, and other interfaces for additional design entry and simulation support from other industry-standard PC- and UNIX workstation-based EDA tools. The MAX+PLUS II software runs on Windows-based PCs and Sun SPARCstation, HP 9000 Series 700/800, and IBM RISC System/6000 workstations.

The MAX+PLUS II software interfaces easily with common gate array EDA tools for synthesis and simulation. For example, the MAX+PLUS II software can generate Verilog HDL files for simulation with tools such as Cadence Verilog-XL. Additionally, the MAX+PLUS II software contains EDA libraries that use device-specific features such as carry chains, which are used for fast counter and arithmetic functions. For instance, the Synopsys Design Compiler library supplied with the MAX+PLUS II development system includes DesignWare functions that are optimized for the FLEX 8000 architecture.



For more information on the MAX+PLUS II software, go to the MAX+PLUS II Programmable Logic Development System & Software Data Sheet.

Functional Description

The FLEX 8000 architecture incorporates a large matrix of compact building blocks called logic elements (LEs). Each LE contains a 4-input LUT that provides combinatorial logic capability and a programmable register that offers sequential logic capability. The fine-grained structure of the LE provides highly efficient logic implementation.

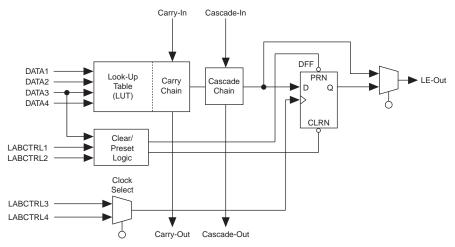
Eight LEs are grouped together to form a logic array block (LAB). Each FLEX 8000 LAB is an independent structure with common inputs, interconnections, and control signals. The LAB architecture provides a coarse-grained structure for high device performance and easy routing.

Each LAB provides four control signals that can be used in all eight LEs. Two of these signals can be used as clocks, and the other two for clear/preset control. The LAB control signals can be driven directly from a dedicated input pin, an I/O pin, or any internal signal via the LAB local interconnect. The dedicated inputs are typically used for global clock, clear, or preset signals because they provide synchronous control with very low skew across the device. FLEX 8000 devices support up to four individual global clock, clear, or preset control signals. If logic is required on a control signal, it can be generated in one or more LEs in any LAB and driven into the local interconnect of the target LAB.

Logic Element

The logic element (LE) is the smallest unit of logic in the FLEX 8000 architecture, with a compact size that provides efficient logic utilization. Each LE contains a 4-input LUT, a programmable flipflop, a carry chain, and cascade chain. Figure 3 shows a block diagram of an LE.

Figure 3. FLEX 8000 LE

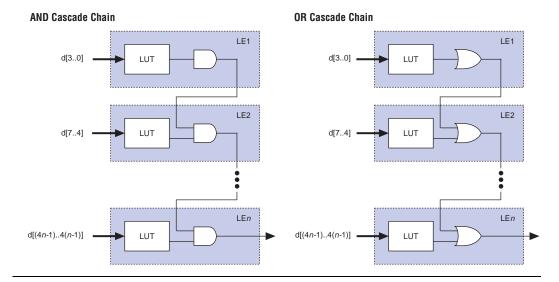


The LUT is a function generator that can quickly compute any function of four variables. The programmable flipflop in the LE can be configured for D, T, JK, or SR operation. The clock, clear, and preset control signals on the flipflop can be driven by dedicated input pins, general-purpose I/O pins, or any internal logic. For purely combinatorial functions, the flipflop is bypassed and the output of the LUT goes directly to the output of the LE.

The MAX+PLUS II Compiler can create cascade chains automatically during design processing; designers can also insert cascade chain logic manually during design entry. Cascade chains longer than eight LEs are automatically implemented by linking LABs together. The last LE of an LAB cascades to the first LE of the next LAB.

Figure 5 shows how the cascade function can connect adjacent LEs to form functions with a wide fan-in. These examples show functions of 4n variables implemented with n LEs. For a device with an A-2 speed grade, the LE delay is 2.4 ns; the cascade chain delay is 0.6 ns. With the cascade chain, 4.2 ns is needed to decode a 16-bit address.

Figure 5. FLEX 8000 Cascade Chain Operation



LE Operating Modes

The FLEX 8000 LE can operate in one of four modes, each of which uses LE resources differently. See Figure 6. In each mode, seven of the ten available inputs to the LE—the four data inputs from the LAB local interconnect, the feedback from the programmable register, and the carry-in and cascade-in from the previous LE—are directed to different destinations to implement the desired logic function. The three remaining inputs to the LE provide clock, clear, and preset control for the register. The MAX+PLUS II software automatically chooses the appropriate mode for each application. Design performance can also be enhanced by designing for the operating mode that supports the desired application.

Normal Mode

The normal mode is suitable for general logic applications and wide decoding functions that can take advantage of a cascade chain. In normal mode, four data inputs from the LAB local interconnect and the carry-in signal are the inputs to a 4-input LUT. Using a configurable SRAM bit, the MAX+PLUS II Compiler automatically selects the carry-in or the DATA3 signal as an input. The LUT output can be combined with the cascade-in signal to form a cascade chain through the cascade-out signal. The LE-Out signal—the data output of the LE—is either the combinatorial output of the LUT and cascade chain, or the data output (Q) of the programmable register.

Arithmetic Mode

The arithmetic mode offers two 3-input LUTs that are ideal for implementing adders, accumulators, and comparators. One LUT provides a 3-bit function; the other generates a carry bit. As shown in Figure 6, the first LUT uses the carry-in signal and two data inputs from the LAB local interconnect to generate a combinatorial or registered output. For example, in an adder, this output is the sum of three bits: a, b, and the carry-in. The second LUT uses the same three signals to generate a carry-out signal, thereby creating a carry chain. The arithmetic mode also supports a cascade chain.

Up/Down Counter Mode

The up/down counter mode offers counter enable, synchronous up/down control, and data loading options. These control signals are generated by the data inputs from the LAB local interconnect, the carry-in signal, and output feedback from the programmable register. Two 3-input LUTs are used: one generates the counter data, and the other generates the fast carry bit. A 2-to-1 multiplexer provides synchronous loading. Data can also be loaded asynchronously with the clear and preset register control signals, without using the LUT resources.

Clearable Counter Mode

The clearable counter mode is similar to the up/down counter mode, but supports a synchronous clear instead of the up/down control; the clear function is substituted for the cascade-in signal in the up/down counter mode. Two 3-input LUTs are used: one generates the counter data, and the other generates the fast carry bit. Synchronous loading is provided by a 2-to-1 multiplexer, and the output of this multiplexer is ANDed with a synchronous clear.

Each LE in an LAB can drive up to two separate column interconnect channels. Therefore, all 16 available column channels can be driven by the LAB. The column channels run vertically across the entire device, and share access to LABs in the same column but in different rows. The MAX+PLUS II Compiler chooses which LEs must be connected to a column channel. A row interconnect channel can be fed by the output of the LE or by two column channels. These three signals feed a multiplexer that connects to a specific row channel. Each LE is connected to one 3-to-1 multiplexer. In an LAB, the multiplexers provide all 16 column channels with access to 8 row channels.

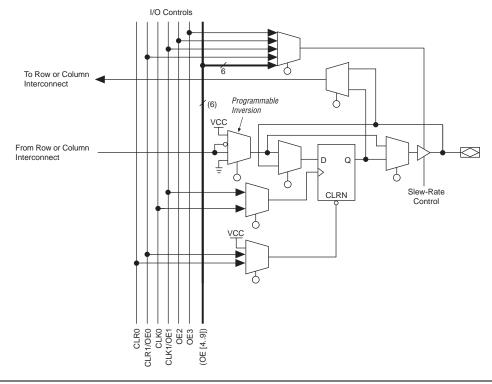
Each column of LABs has a dedicated column interconnect that routes signals out of the LABs into the column. The column interconnect can then drive I/O pins or feed into the row interconnect to route the signals to other LABs in the device. A signal from the column interconnect, which can be either the output of an LE or an input from an I/O pin, must transfer to the row interconnect before it can enter an LAB. Table 4 summarizes the FastTrack Interconnect resources available in each FLEX 8000 device.

Table 4. FLEX 8000 FastTrack Interconnect Resources											
Device	Rows	Channels per Row	Columns	Channels per Column							
EPF8282A EPF8282AV	2	168	13	16							
EPF8452A	2	168	21	16							
EPF8636A	3	168	21	16							
EPF8820A	4	168	21	16							
EPF81188A	6	168	21	16							
EPF81500A	6	216	27	16							

Figure 9 shows the interconnection of four adjacent LABs, with row, column, and local interconnects, as well as the associated cascade and carry chains.

Figure 10. FLEX 8000 IOE

Numbers in parentheses are for EPF81500A devices only.

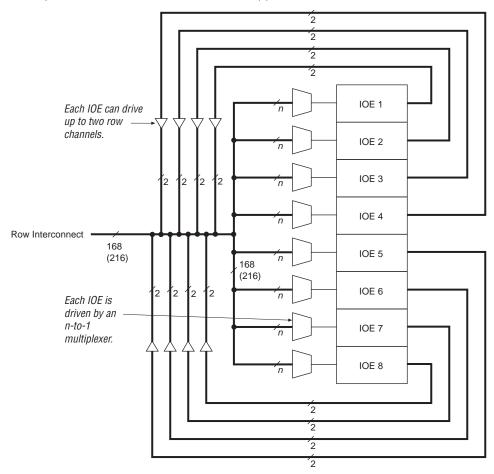


Row-to-IOE Connections

Figure 11 illustrates the connection between row interconnect channels and IOEs. An input signal from an IOE can drive two separate row channels. When an IOE is used as an output, the signal is driven by an *n*-to-1 multiplexer that selects the row channels. The size of the multiplexer varies with the number of columns in a device. EPF81500A devices use a 27-to-1 multiplexer; EPF81188A, EPF8820A, EPF8636A, and EPF8452A devices use a 21-to-1 multiplexer; and EPF8282A and EPF8282AV devices use a 13-to-1 multiplexer. Eight IOEs are connected to each side of the row channels.

Figure 11. FLEX 8000 Row-to-IOE Connections

Numbers in parentheses are for EPF81500A devices. See Note (1).



Note:

- (1) n = 13 for EPF8282A and EPF8282AV devices.
 - *n* = 21 for EPF8452A, EPF8636A, EPF8820A, and EPF81188A devices.
 - n = 27 for EPF81500A devices.

Column-to-IOE Connections

Two IOEs are located at the top and bottom of the column channels (see Figure 12). When an IOE is used as an input, it can drive up to two separate column channels. The output signal to an IOE can choose from 8 of the 16 column channels through an 8-to-1 multiplexer.

The instruction register length for FLEX 8000 devices is three bits. Table 7 shows the boundary-scan register length for FLEX 8000 devices.

Table 7. FLEX 8000 Boundary-Scan Register Length							
Device Boundary-Scan Register Length							
EPF8282A, EPF8282AV	273						
EPF8636A	417						
EPF8820A	465						
EPF81500A	645						

FLEX 8000 devices that support JTAG include weak pull-ups on the JTAG pins. Figure 14 shows the timing requirements for the JTAG signals.

TDI

TCK

t_{JCP}

t_{JCL}

t_{JPSU}

t_{JPSU}

t_{JPNZ}

TDO

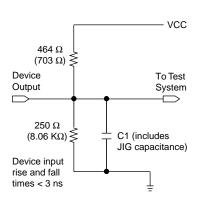
Signal to Be Captured
Signal to Be Driven

Figure 14. EPF8282A, EPF8282AV, EPF8636A, EPF8820A & EPF81500A JTAG Waveforms

Table 8 shows the timing parameters and values for EPF8282A, EPF8282AV, EPF8636A, EPF8820A, and EPF81500A devices.

Figure 15. FLEX 8000 AC Test Conditions

Power supply transients can affect AC measurements. Simultaneous transitions of multiple outputs should be avoided for accurate measurement. Threshold tests must not be performed under AC conditions. Large-amplitude, fast-groundcurrent transients normally occur as the device outputs discharge the load capacitances. When these transients flow through the parasitic inductance between the device ground pin and the test system ground, significant reductions in observable noise immunity can result. Numbers in parentheses are for 3.3-V devices or outputs. Numbers without parentheses are for 5.0-V devices or outputs.



Operating Conditions

Tables 9 through 12 provide information on absolute maximum ratings, recommended operating conditions, operating conditions, and capacitance for 5.0-V FLEX 8000 devices.

Table 9	Table 9. FLEX 8000 5.0-V Device Absolute Maximum Ratings Note (1)											
Symbol	Parameter	Conditions	Min	Max	Unit							
V _{CC}	Supply voltage	With respect to ground (2)	-2.0	7.0	V							
V _I	DC input voltage		-2.0	7.0	V							
I _{OUT}	DC output current, per pin		-25	25	mA							
T _{STG}	Storage temperature	No bias	-65	150	° C							
T_{AMB}	Ambient temperature	Under bias	-65	135	° C							
T_J	Junction temperature	Ceramic packages, under bias		150	° C							
		PQFP and RQFP, under bias		135	° C							

Table 1	Table 15. FLEX 8000 3.3-V Device DC Operating ConditionsNote (4)												
Symbol	I Parameter Conditions		Min	Тур	Max	Unit							
V _{IH}	High-level input voltage		2.0		V _{CC} + 0.3	V							
V_{IL}	Low-level input voltage		-0.3		0.8	V							
V_{OH}	High-level output voltage	$I_{OH} = -0.1 \text{ mA DC } (5)$	V _{CC} - 0.2			V							
V_{OL}	Low-level output voltage	I _{OL} = 4 mA DC (5)			0.45	V							
I _I	Input leakage current	$V_I = V_{CC}$ or ground	-10		10	μΑ							
I_{OZ}	Tri-state output off-state current	$V_O = V_{CC}$ or ground	-40		40	μΑ							
I _{CC0}	V _{CC} supply current (standby)	V _I = ground, no load (6)		0.3	10	mA							

Table 16. FLEX 8000 3.3-V Device CapacitanceNote (7)									
Symbol	Parameter	Conditions	Min	Max	Unit				
C _{IN}	Input capacitance	V _{IN} = 0 V, f = 1.0 MHz		10	pF				
C _{OUT}	Output capacitance	V _{OUT} = 0 V, f = 1.0 MHz		10	pF				

Notes to tables:

- (1) See the Operating Requirements for Altera Devices Data Sheet.
- (2) Minimum DC input voltage is –0.3 V. During transitions, the inputs may undershoot to –2.0 V or overshoot to 5.3 V for input currents less than 100 mA and periods shorter than 20 ns.
- (3) The maximum V_{CC} rise time is 100 ms. V_{CC} must rise monotonically.
- (4) These values are specified in Table 14 on page 29.
- (5) The I_{OH} parameter refers to high-level TTL output current; the I_{OL} parameter refers to low-level TTL output current.
- (6) Typical values are for $T_A = 25^{\circ}$ C and $V_{CC} = 3.3$ V.
- (7) Capacitance is sample-tested only.

Figure 16 shows the typical output drive characteristics of 5.0-V FLEX 8000 devices. The output driver is compliant with *PCI Local Bus Specification, Revision 2.2*.

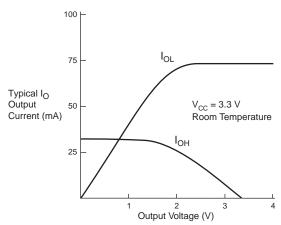


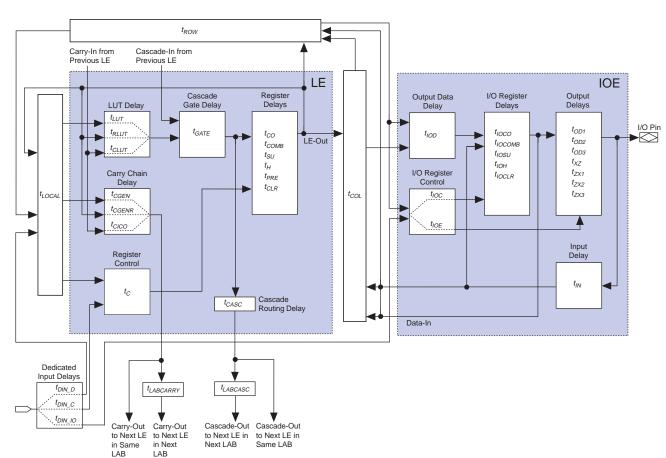
Figure 18. Output Drive Characteristics of EPF8282AV Devices

Timing Model

The continuous, high-performance FastTrack Interconnect routing structure ensures predictable performance and accurate simulation and timing analysis. This predictable performance contrasts with that of FPGAs, which use a segmented connection scheme and hence have unpredictable performance. Timing simulation and delay prediction are available with the MAX+PLUS II Simulator and Timing Analyzer, or with industry-standard EDA tools. The Simulator offers both pre-synthesis functional simulation to evaluate logic design accuracy and post-synthesis timing simulation with 0.1-ns resolution. The Timing Analyzer provides point-to-point timing delay information, setup and hold time prediction, and device-wide performance analysis.

Tables 17 through 20 describe the FLEX 8000 timing parameters and their symbols.

Figure 19. FLEX 8000 Timing Model



Symbol		Speed Grade								
	А	-2	A-3		A-4					
	Min	Max	Min	Max	Min	Max				
t_{IOD}		0.7		0.8		0.9	ns			
t _{IOC}		1.7		1.8		1.9	ns			
t _{IOE}		1.7		1.8		1.9	ns			
t _{IOCO}		1.0		1.0		1.0	ns			
t _{IOCOMB}		0.3		0.2		0.1	ns			
t_{IOSU}	1.4		1.6		1.8		ns			
t_{IOH}	0.0		0.0		0.0		ns			
t_{IOCLR}		1.2		1.2		1.2	ns			
t_{IN}		1.5		1.6		1.7	ns			
t_{OD1}		1.1		1.4		1.7	ns			
t_{OD2}		-		-		-	ns			
t_{OD3}		4.6		4.9		5.2	ns			
t_{XZ}		1.4		1.6		1.8	ns			
t_{ZX1}		1.4		1.6		1.8	ns			
t_{ZX2}		-		-		-	ns			
t_{ZX3}		4.9		5.1		5.3	ns			

Symbol			Speed	Grade			Unit
	A-2		A-3		A-4		1
	Min	Max	Min	Max	Min	Max	
t _{LABCASC}		0.3		0.4		0.4	ns
t _{LABCARRY}		0.3		0.4		0.4	ns
t _{LOCAL}		0.5		0.5		0.7	ns
t _{ROW}		5.0		5.0		5.0	ns
t_{COL}		3.0		3.0		3.0	ns
t _{DIN_C}		5.0		5.0		5.5	ns
t _{DIN_D}		7.0		7.0		7.5	ns
t _{DIN IO}		5.0		5.0		5.5	ns

Table 34. EPF8636A I/O Element Timing Parameters										
Symbol	Speed Grade									
	A-2		A	1-3	А	1-4				
	Min	Max	Min	Max	Min	Max				
t_{IOD}		0.7		0.8		0.9	ns			
t _{IOC}		1.7		1.8		1.9	ns			
t _{IOE}		1.7		1.8		1.9	ns			
t _{IOCO}		1.0		1.0		1.0	ns			
t _{IOCOMB}		0.3		0.2		0.1	ns			
t _{IOSU}	1.4		1.6		1.8		ns			
t _{IOH}	0.0		0.0		0.0		ns			
t _{IOCLR}		1.2		1.2		1.2	ns			
t _{IN}		1.5		1.6		1.7	ns			
t _{OD1}		1.1		1.4		1.7	ns			
t _{OD2}		1.6		1.9		2.2	ns			
t _{OD3}		4.6		4.9		5.2	ns			
t_{XZ}		1.4		1.6		1.8	ns			
t_{ZX1}		1.4		1.6		1.8	ns			
t_{ZX2}		1.9		2.1		2.3	ns			
t_{ZX3}		4.9		5.1		5.3	ns			

Symbol			Speed (Grade			Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	1
t _{LABCASC}		0.3		0.4		0.4	ns
t _{LABCARRY}		0.3		0.4		0.4	ns
t _{LOCAL}		0.5		0.5		0.7	ns
t _{ROW}		5.0		5.0		5.0	ns
t_{COL}		3.0		3.0		3.0	ns
t _{DIN_C}		5.0		5.0		5.5	ns
t _{DIN_D}		7.0		7.0		7.5	ns
t _{DIN IO}		5.0		5.0		5.5	ns

Symbol	Speed Grade						
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{IOD}		0.7		0.8		0.9	ns
t_{IOC}		1.7		1.8		1.9	ns
t_{IOE}		1.7		1.8		1.9	ns
t _{IOCO}		1.0		1.0		1.0	ns
t_{IOCOMB}		0.3		0.2		0.1	ns
t _{IOSU}	1.4		1.6		1.8		ns
t _{IOH}	0.0		0.0		0.0		ns
t _{IOCLR}		1.2		1.2		1.2	ns
t _{IN}		1.5		1.6		1.7	ns
t _{OD1}		1.1		1.4		1.7	ns
t _{OD2}		1.6		1.9		2.2	ns
t _{OD3}		4.6		4.9		5.2	ns
t_{XZ}		1.4		1.6		1.8	ns
t_{ZX1}		1.4		1.6		1.8	ns
t_{ZX2}		1.9		2.1		2.3	ns
t_{ZX3}		4.9		5.1		5.3	ns

Symbol	Speed Grade						
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	1
t _{LABCASC}		0.3		0.3		0.4	ns
t _{LABCARRY}		0.3		0.3		0.4	ns
t _{LOCAL}		0.5		0.6		0.8	ns
t _{ROW}		5.0		5.0		5.0	ns
t_{COL}		3.0		3.0		3.0	ns
t _{DIN_C}		5.0		5.0		5.5	ns
t _{DIN_D}		7.0		7.0		7.5	ns
t _{DIN IO}		5.0		5.0		5.5	ns

Power Consumption

The supply power (P) for FLEX 8000 devices can be calculated with the following equation:

$$P = P_{INT} + P_{IO} = [(I_{CCSTANDBY} + I_{CCACTIVE}) \times V_{CC}] + P_{IO}$$

Typical $I_{CCSTANDBY}$ values are shown as I_{CC0} in Table 11 on page 28 and Table 15 on page 30. The P_{IO} value, which depends on the device output load characteristics and switching frequency, can be calculated using the guidelines given in *Application Note 74 (Evaluating Power for Altera Devices)*. The $I_{CCACTIVE}$ value depends on the switching frequency and the application logic. This value can be calculated based on the amount of current that each LE typically consumes.

The following equation shows the general formula for calculating I_{CCACTIVE} :

$$I_{CCACTIVE} \, = \, K \times f_{MAX} \times N \times tog_{LC} \times \frac{\mu A}{MHz \times LE}$$

The parameters in this equation are shown below:

f_{MAX} = Maximum operating frequency in MHz
 N = Total number of logic cells used in the device

tog_{LC} = Average percentage of logic cells toggling at each clock

K = Constant, shown in Table 50

Table 50. Values for Constant K						
Device	K					
5.0-V FLEX 8000 devices	75					
3.3-V FLEX 8000 devices	60					

This calculation provides an I_{CC} estimate based on typical conditions with no output load. The actual I_{CC} value should be verified during operation because this measurement is sensitive to the actual pattern in the device and the environmental operating conditions.

Figure 20 shows the relationship between I_{CC} and operating frequency for several LE utilization values.

Operating Modes

The FLEX 8000 architecture uses SRAM elements that require configuration data to be loaded whenever the device powers up and begins operation. The process of physically loading the SRAM programming data into the device is called *configuration*. During initialization, which occurs immediately after configuration, the device resets registers, enables I/O pins, and begins to operate as a logic device. The I/O pins are tri-stated during power-up, and before and during configuration. The configuration and initialization processes together are called *command mode*; normal device operation is called *user mode*.

SRAM elements allow FLEX 8000 devices to be reconfigured in-circuit with new programming data that is loaded into the device. Real-time reconfiguration is performed by forcing the device into command mode with a device pin, loading different programming data, reinitializing the device, and resuming user-mode operation. The entire reconfiguration process requires less than 100 ms and can be used to dynamically reconfigure an entire system. In-field upgrades can be performed by distributing new configuration files.

Configuration Schemes

The configuration data for a FLEX 8000 device can be loaded with one of six configuration schemes, chosen on the basis of the target application. Both active and passive schemes are available. In the active configuration schemes, the FLEX 8000 device functions as the controller, directing the loading operation, controlling external configuration devices, and completing the loading process. The clock source for all active configuration schemes is an oscillator on the FLEX 8000 device that operates between 2 MHz and 6 MHz. In the passive configuration schemes, an external controller guides the FLEX 8000 device. Table 51 shows the data source for each of the six configuration schemes.

Table 51. Data Source for Configuration							
Configuration Scheme	Acronym	Data Source					
Active serial	AS	Altera configuration device					
Active parallel up	APU	Parallel configuration device					
Active parallel down	APD	Parallel configuration device					
Passive serial	PS	Serial data path					
Passive parallel synchronous	PPS	Intelligent host					
Passive parallel asynchronous	PPA	Intelligent host					

Pin Name	84-Pin	84-Pin	100-Pin	100-Pin	144-Pin	160-Pin	160-Pin
	PLCC EPF8282A	PLCC EPF8452A EPF8636A	TQFP EPF8282A EPF8282AV	TQFP EPF8452A	TQFP EPF8820A	PGA EPF8452A	PQFP EPF8820A (1)
ADD0	78	76	78	77	106	N3	6
DATA7	3	2	90	89	131	P8	140
DATA6	4	4	91	91	132	P10	139
DATA5	6	6	92	95	133	R12	138
DATA4	7	7	95	96	134	R13	136
DATA3	8	8	97	97	135	P13	135
DATA2	9	9	99	98	137	R14	133
DATA1	13	13	4	4	138	N15	132
DATA0	14	14	5	5	140	K13	129
SDOUT (3)	79	78	79	79	23	P4	97
TDI (4)	55	45 (5)	54	_	96	_	17
TDO (4)	27	27 (5)	18	_	18	_	102
TCK (4), (6)	72	44 (5)	72	_	88	_	27
TMS (4)	20	43 (5)	11	_	86	_	29
TRST (7)	52	52 (8)	50	_	71	_	45
Dedicated	12, 31, 54,	12, 31, 54,	3, 23, 53, 73	3, 24, 53,	9, 26, 82,	C3, D14,	14, 33, 94,
Inputs (10)	73	73		74	99	N2, R15	113
VCCINT	17, 38, 59, 80	17, 38, 59, 80	6, 20, 37, 56, 70, 87	9, 32, 49, 59, 82	8, 28, 70, 90, 111	B2, C4, D3, D8, D12, G3, G12, H4, H13, J3, J12, M4, M7, M9, M13, N12	3, 24, 46, 92, 114, 160
VCCIO	-	_	_	_	16, 40, 60, 69, 91, 112, 122, 141	_	23, 47, 57, 69, 79, 104, 127, 137, 149, 159

Pin Name	160-Pin PQFP EPF8452A	160-Pin PQFP EPF8636A	192-Pin PGA EPF8636A EPF8820A	208-Pin PQFP EPF8636A (1)	208-Pin PQFP EPF8820A (1)	208-Pin PQFP EPF81188A <i>(1)</i>
nSP (2)	120	1	R15	207	207	5
MSELO (2)	117	3	T15	4	4	21
MSEL1 (2)	84	38	Т3	49	49	33
nSTATUS (2)	37	83	B3	108	108	124
nCONFIG (2)	40	81	C3	103	103	107
DCLK (2)	1	120	C15	158	158	154
CONF_DONE (2)	4	118	B15	153	153	138
nWS	30	89	C5	114	114	118
nRS	71	50	B5	66	116	121
RDCLK	73	48	C11	64	137	137
nCS	29	91	B13	116	145	142
CS	27	93	A16	118	148	144
RDYnBUSY	125	155	A8	201	127	128
CLKUSR	76	44	A10	59	134	134
ADD17	78	43	R5	57	43	46
ADD16	91	33	U3	43	42	45
ADD15	92	31	T5	41	41	44
ADD14	94	29	U4	39	40	39
ADD13	95	27	R6	37	39	37
ADD12	96	24	T6	31	35	36
ADD11	97	23	R7	30	33	31
ADD10	98	22	T7	29	31	30
ADD9	99	21	Т8	28	29	29
ADD8	101	20	U9	24	25	26
ADD7	102	19	U10	23	23	25
ADD6	103	18	U11	22	21	24
ADD5	104	17	U12	21	19	18
ADD4	105	13	R12	14	14	17
ADD3	106	11	U14	12	13	16
ADD2	109	9	U15	10	11	10
ADD1	110	7	R13	8	10	9
ADD0	123	157	U16	203	9	8
DATA7	144	137	H17	178	178	177
DATA6	150	132	G17	172	176	175
DATA5	152	129	F17	169	174	172